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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

U.S. Serial No. 10/750,251) I hereby certify that this paper (and/or fee)
Applicants: Young Hun Seo) is being deposited with the United States
Title: Method For Fabricating) Postal Service as first class mail in an
Silicon on Insulator Substrates) envelope addressed to:
For Use In Semiconductor) Mail Stop Amendment
Devices) Commissioner for Patents
Filed: December 31, 2003) P.O. Box 1450
) Alexandria, VA 22313-1450
) on this date:
TC/AU: 2826) Dated: August 12, 2005
Examiner: Pert)
Docket No.: 20059/PIA31199) 
) Mark C. Zimmerman
) Registration No. 44,006

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO THE OFFICE ACTION DATED MAY 12, 2005

Dear Sir:

Please enter the following amendments and consider the following remarks.

Changes to the Specification begin on page 2 of this paper.

The Status of the Claims is reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 4 of this paper.